

YI J I N ELECTRONI CS CO. , LTD

产品承认书

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EHS

dient客户:

Product产品:

Model型号:

Tabulation 制表:

"Date日期:

声表面谐振器

R315M F11-DIP

Production

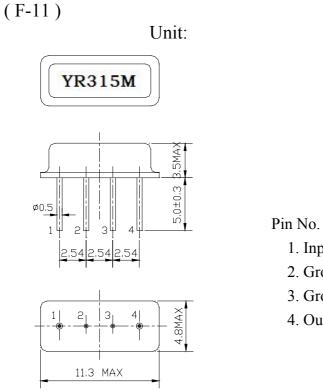
2011-5-1

承認結果	客戶簽名	客戶承認章	日期	備注
CONCLUSION	SIGNATURE	STAMP	DATE	REMARK
合格				
ACCEPT				
不合格				
REJECT				

审核:____

(请盖公章)

1. Package Dimension



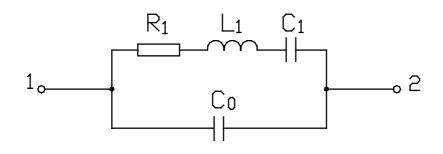
Pin No. Function

mm

- 1. Input
- 2. Ground
- 3. Ground
- 4. Output

2. Marking

- YJ 315.00
- 1. Color: Black or Blue
- 2. DR: Manufacture's logo
- 3. 1: One-port SAW Resonator
- 4. 315.00: Center Frequency (MHz)
- 3. Equivalent LC Model



4. Performance

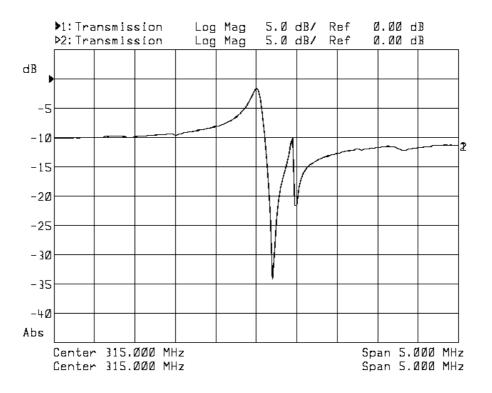
4.1 Maximum Rating

DC Voltage V _{DC}	10V		
AC Voltage V _{PP}	10V (50Hz/60Hz)		
Operation Temperature	-40 °C to +85°C		
Storage Temperature	-45 °C to +85°C		
RF Power Dissipation	0dBm		

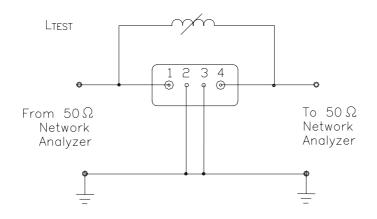
4.2 Electronic Characteristics

Item		Units	Minimum	Typical	Maximum
Center Frequency fo		MHz	314.925	315	315.075
Insertion Loss		dB		1.3	2.5
Quality Factor	Unloaded Q			12,000	
	50Ω Loaded Q			1,900	
Tem perature	Turnover Temperature	°C	10	25	40
Stability	Turnover Frequency	KHz		fo	
	Freq.Temp.Coefficient	ppm/°C ²		0.037	
Frequency Aging		ppm/yr		<±10	
DC Insulation Resistance		ΜΩ	1.0		
RF Equivalent RLC Model	Motional Resistance R ₁	Ω		23	29
	Motional Inductance L ₁	μH		115.2	
	Motional Capacitance C ₁	fF	_	2.2	
	Shunt Static Capacitance Co	pF	2.1	2.4	2.7

4.3 Frequency Characteristics



4.4 Test Circuit



Note: Reference temperature shall be $25 \pm 2^{\circ}$ C. However, the measurement may be carried out at 5°C to 35°C unless there is a dispute.

5. Reliability

5.1 Mechanical Shock: The components shall remain within the electrical specifications after 1000 shocks, acceleration 392 m/s^2 , duration 6 milliseconds.

5.2 Vibration Fatigue: The components shall remain within the electrical specifications after loaded vibration at 20 Hz, amplitude 1.5 mm, for 2 hours.

5.3 Terminal Strength: The components shall remain within the electrical specifications after pulled 2 kgs weight for 10 seconds towards an axis of each terminal.

5.4 High Temperature Storage: The components shall remain within the electrical specifications after being kept at the $85^{\circ}C \pm 2^{\circ}C$ for 48 hours, then kept at room temperature for 2 hours.

5.5 Low Temperature Storage: The components shall remain within the electrical specifications after being kept at the $-25^{\circ}C \pm 2^{\circ}C$ for 48 hours, then kept at room temperature for 2 hours.

5.6 Temperature Cycle: The components shall remain within the electrical specifications after 5 cycles of high and low temperature testing (one cycle: 80° C for 30 minutes \rightarrow 25°C for 5 minutes \rightarrow -25°C for 30 minutes)than kept at room temperature for 2 hours.

5.7 Solder-heat Resistance: The components shall remain within the electrical specifications after dipped in the solder at 260 °C for 10 ± 1 seconds, then kept at room temperature for 2 hours. (Terminal must be dipped leaving 1.5 mm from the case).

5.8 Solderability: Solderability of terminal shall be kept at more than 80% after dipped in the solder flux at $230^{\circ}C \pm 5^{\circ}C$ for 5 ± 1 seconds.

6. Remarks

6.1 Static voltage

Static voltage between signal load & ground may cause deterioration & destruction of the component. Please avoid static voltage.

6.2 Ultrasonic cleaning

Ultrasonic vibration may cause deterioration & destruction of the component. Please avoid ultrasonic cleaning.

6.3 Soldering

Only leads of component may be soldered. Please avoid soldering another part of component.